Power MOSFET

30 V, 2.5 A, Single N-Channel, SOT-23

Features

- Leading Planar Technology for Low Gate Charge / Fast Switching
- 4.5 V Rated for Low Voltage Gate Drive
- SOT-23 Surface Mount for Small Footprint (3 x 3 mm)
- NV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Applications

- DC–DC Conversion
- Load/Power Switch for Portables
- Load/Power Switch for Computing

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	30	V
Gate-to-Source Voltage	Gate-to-Source Voltage			±20	V
Continuous Drain Current (Note 1)	Steady State	$T_A = 25^{\circ}C$	I _D	2.0	А
		T _A = 85°C		1.5	
	$t \le 10 s$	$T_A = 25^{\circ}C$		2.5	
Power Dissipation (Note 1)	Steady State	$T_A = 25^{\circ}C$	P _D	0.73	W
Continuous Drain	Steady State	$T_A = 25^{\circ}C$	Ι _D	1.5	А
Current (Note 2)		T _A = 85°C		1.1	
Power Dissipation (Note 2)		$T_A = 25^{\circ}C$	PD	0.42	W
Pulsed Drain Current	t _p =	=10 μs	I _{DM}	10	А
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to 150	°C
Source Current (Body Diode)			۱ _S	2.0	А
Peak Source Current (Diode Forward)		t _p = 10 μs	I _{SM}	4.0	A
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Мах	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	170	°C/W
Junction-to-Ambient - t < 10 s (Note 1)	R_{\thetaJA}	100	
Junction-to-Ambient - Steady State (Note 2)	R_{\thetaJA}	300	

1. Surface-mounted on FR4 board using 1 in sq pad size.

2. Surface-mounted on FR4 board using the minimum recommended pad size.

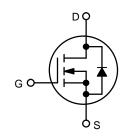


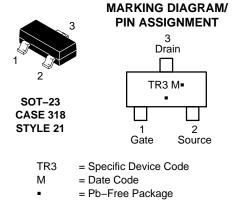
ON Semiconductor®

www.onsemi.com

V _{(BR)DSS}	R _{DS(on)} TYP	I _D MAX	
30 V	85 mΩ @ 10 V	2.5 A	
	105 mΩ @ 4.5 V		







(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
NTR4503NT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel
NVTR4503NT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
OFF CHARACTERISTICS		•				
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A	30	36		V
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V, V_{DS} = 24 V$			1.0	μA
		$V_{GS} = 0 V, V_{DS} = 24 V, T_{J} = 125^{\circ}C$			10	
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS} = ±20 V			±100	nA
ON CHARACTERISTICS (Note 3)	•	•				
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	1.0	1.75	3.0	V
Drain-to-Source On-Resistance	R _{DS(on)}	V_{GS} = 10 V, I _D = 2.5 A		85	110	mΩ
		V_{GS} = 4.5 V, I _D = 2.0 A		105	140	
Forward Transconductance	9FS	$V_{DS} = 4.5 \text{ V}, I_{D} = 2.5 \text{ A}$		5.3		S
CHARGES AND CAPACITANCES		•				
Input Capacitance	C _{iss}			135		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 15 V		52		-
Reverse Transfer Capacitance	C _{rss}	v _{DS} = 15 v		15		
Input Capacitance	C _{iss}			130	250	pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 24 V		42	75	
Reverse Transfer Capacitance	C _{rss}	VDS - 24 V		13	25	
Total Gate Charge	Q _{G(TOT)}			3.6	7.0	nC
Threshold Gate Charge	Q _{G(TH)}	V _{CS} = 10 V. V _{DS} = 15 V.		0.3		
Gate-to-Source Charge	Q _{GS}	$V_{GS} = 10 \text{ V}, V_{DS} = 15 \text{ V},$ $I_D = 2.5 \text{ A}$		0.6		
Gate-to-Drain Charge	Q _{GD}			0.7		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 24 V, I _D = 2.5 A		1.9		nC
Threshold Gate Charge	Q _{G(TH)}			0.3		
Gate-to-Source Charge	Q _{GS}			0.6		
Gate-to-Drain Charge	Q _{GD}			0.9		
SWITCHING CHARACTERISTICS (No	ote 4)	•				4
Turn–On Delay Time	t _{d(on)}			5.8	12	ns
Rise Time	t _r	V _{GS} = 10 V, V _{DD} = 15 V,		5.8	10	1
Turn–Off Delay Time	t _{d(off)}	$I_D = 1 \text{ A}, R_G = 6 \Omega$		14	25	
Fall Time	t _f			1.6	5.0	1
Turn–On Delay Time	t _{d(on)}			4.8		ns
Rise Time	t _r	V_{GS} = 10 V, V_{DD} = 24 V, I _D = 2.5 A, R _G = 2.5 Ω		6.7		
Turn–Off Delay Time	t _{d(off)}			13.6		
Fall Time	t _f			1.8		
DRAIN-SOURCE DIODE CHARACTE	RISTICS	-	-	-		-
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V, I_{S} = 2.0 A$		0.85	1.2	V
0						

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2%. 4. Switching characteristics are independent of operating junction temperatures.

 $\label{eq:VGS} \begin{array}{l} \mathsf{V}_{GS} = 0 \ \mathsf{V}, \ \mathsf{I}_S = 2.0 \ \mathsf{A}, \\ \mathsf{dI}_S / \mathsf{dt} = 100 \ \mathsf{A} / \mu s \end{array}$

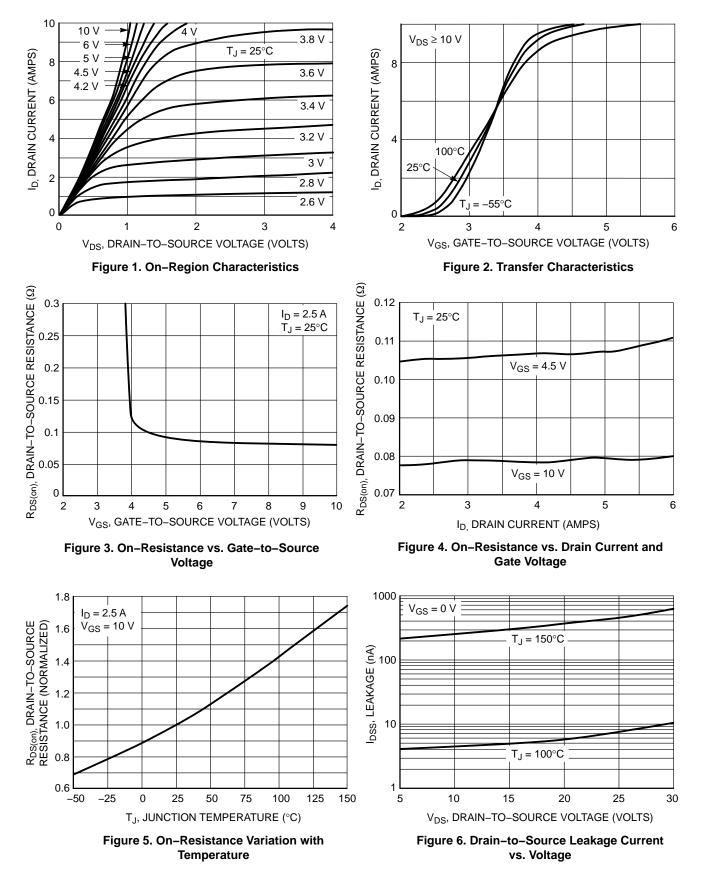
4.0

nC

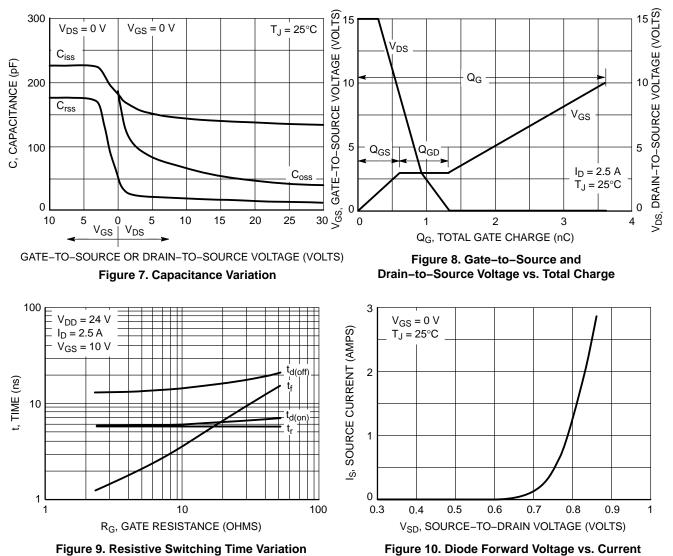
Reverse Recovery Charge

Q_{RR}

TYPICAL PERFORMANCE CURVES



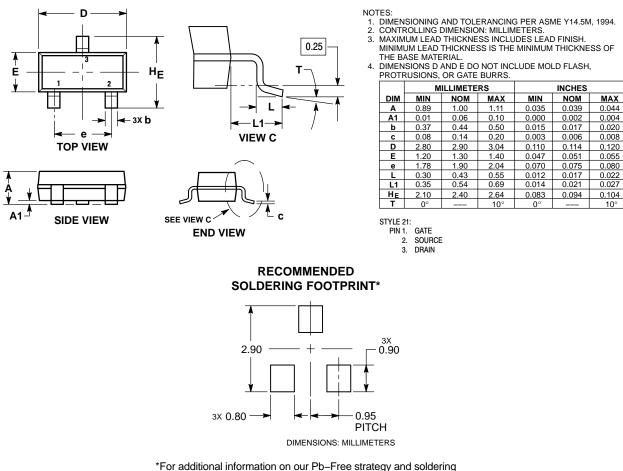
TYPICAL PERFORMANCE CURVES



vs. Gate Resistance

PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 ISSUE AR



For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns me rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor asy products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application. Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufac

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada Fax: 303–675–2176 or 800–344–3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support:

Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81–3–5817–1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ON Semiconductor: NTR4503NT1G NVTR4503NT1G